

### FEATURES

**Primary output frequency range: 65 MHz to 400 MHz**  
**Auxiliary divider from 2 to 31, output from 1.1 MHz to 200 MHz**  
**3.0 V to 3.6 V power supply**  
**1.8 V logic compatibility**  
**Integer-N synthesizer**  
**Programmable output power level**  
**3-wire serial interface**  
**Digital lock detect**  
**Software power-down mode**

### APPLICATIONS

**System clock generation**  
**Test equipment**  
**Wireless LANs**  
**CATV equipment**

### GENERAL DESCRIPTION

The ADF4360-9 is an integrated integer-N synthesizer and voltage-controlled oscillator (VCO). External inductors set the ADF4360-9 center frequency. This allows a VCO frequency range of between 65 MHz and 400 MHz.

An additional divider stage allows division of the VCO signal. The CMOS level output is equivalent to the VCO signal divided by the integer value between 2 and 31. This divided signal can be further divided by 2, if desired.

Control of all the on-chip registers is through a simple 3-wire interface. The device operates with a power supply ranging from 3.0 V to 3.6 V and can be powered down when not in use.

### FUNCTIONAL BLOCK DIAGRAM

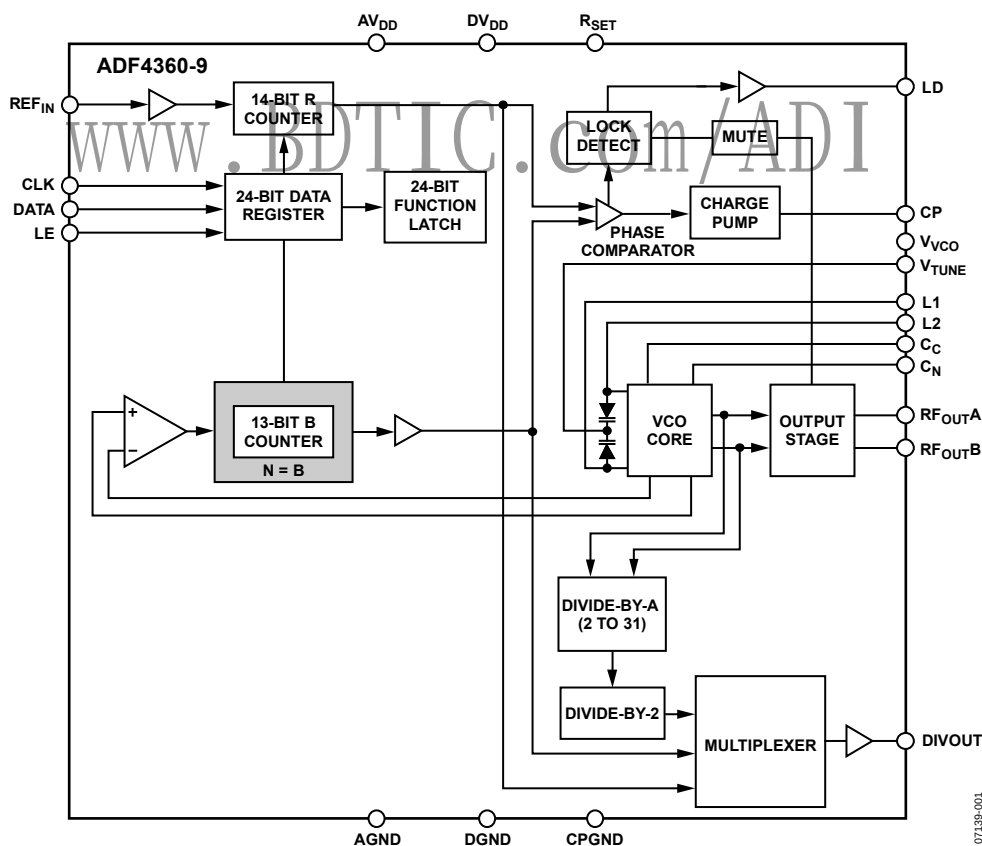


Figure 1.

#### Rev. A

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## REVISION HISTORY

### 3/08—Rev. 0 to Rev. A

|                                         |    |
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| Changes to Table 1 .....                | 3  |
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### 1/08—Revision 0: Initial Version

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## SPECIFICATIONS

$AV_{DD} = DV_{DD} = V_{VCO} = 3.3 \text{ V} \pm 10\%$ ;  $AGND = DGND = 0 \text{ V}$ ;  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.<sup>1</sup>

Table 1.

| Parameter                                         | B Version                       | Unit                          | Conditions/Comments                                                                                              |
|---------------------------------------------------|---------------------------------|-------------------------------|------------------------------------------------------------------------------------------------------------------|
| <b>REF<sub>IN</sub> CHARACTERISTICS</b>           |                                 |                               |                                                                                                                  |
| REF <sub>IN</sub> Input Frequency                 | 10/250                          | MHz min/MHz max               | For $f < 10 \text{ MHz}$ , use a dc-coupled, CMOS-compatible square wave, slew rate $> 21 \text{ V}/\mu\text{s}$ |
| REF <sub>IN</sub> Input Sensitivity               | $0.7/AV_{DD}$<br>0 to $AV_{DD}$ | V p-p min/V p-p max<br>V max  | AC-coupled<br>CMOS-compatible                                                                                    |
| REF <sub>IN</sub> Input Capacitance               | 5.0                             | pF max                        |                                                                                                                  |
| REF <sub>IN</sub> Input Current                   | $\pm 60$                        | $\mu\text{A}$ max             |                                                                                                                  |
| <b>PHASE DETECTOR</b>                             |                                 |                               |                                                                                                                  |
| Phase Detector Frequency <sup>2</sup>             | 8                               | MHz max                       |                                                                                                                  |
| <b>CHARGE PUMP</b>                                |                                 |                               |                                                                                                                  |
| I <sub>CP</sub> Sink/Source <sup>3</sup>          |                                 |                               | With $R_{SET} = 4.7 \text{ k}\Omega$                                                                             |
| High Value                                        | 2.5                             | mA typ                        |                                                                                                                  |
| Low Value                                         | 0.312                           | mA typ                        |                                                                                                                  |
| R <sub>SET</sub> Range                            | 2.7/10                          | k $\Omega$ min/k $\Omega$ max |                                                                                                                  |
| I <sub>CP</sub> Three-State Leakage Current       | 0.2                             | nA typ                        |                                                                                                                  |
| Sink and Source Current Matching                  | 2                               | % typ                         | $1.25 \text{ V} \leq V_{CP} \leq 2.5 \text{ V}$                                                                  |
| I <sub>CP</sub> vs. V <sub>CP</sub>               | 1.5                             | % typ                         | $1.25 \text{ V} \leq V_{CP} \leq 2.5 \text{ V}$                                                                  |
| I <sub>CP</sub> vs. Temperature                   | 2                               | % typ                         | $V_{CP} = 2.0 \text{ V}$                                                                                         |
| <b>LOGIC INPUTS</b>                               |                                 |                               |                                                                                                                  |
| Input High Voltage, V <sub>INH</sub>              | 1.5                             | V min                         |                                                                                                                  |
| Input Low Voltage, V <sub>INL</sub>               | 0.6                             | V max                         |                                                                                                                  |
| Input Current, I <sub>INH</sub> /I <sub>INL</sub> | $\pm 1$                         | $\mu\text{A}$ max             |                                                                                                                  |
| Input Capacitance, C <sub>IN</sub>                | 3.0                             | pF max                        |                                                                                                                  |
| <b>LOGIC OUTPUTS</b>                              |                                 |                               |                                                                                                                  |
| Output High Voltage, V <sub>OH</sub>              | $DV_{DD} - 0.4$                 | V min                         | CMOS output chosen                                                                                               |
| Output High Current, I <sub>OH</sub>              | 500                             | $\mu\text{A}$ max             |                                                                                                                  |
| Output Low Voltage, V <sub>OL</sub>               | 0.4                             | V max                         | I <sub>OL</sub> = 500 $\mu\text{A}$                                                                              |
| <b>POWER SUPPLIES</b>                             |                                 |                               |                                                                                                                  |
| AV <sub>DD</sub>                                  | 3.0/3.6                         | V min/V max                   |                                                                                                                  |
| DV <sub>DD</sub>                                  | AV <sub>DD</sub>                |                               |                                                                                                                  |
| V <sub>VCO</sub>                                  | AV <sub>DD</sub>                |                               |                                                                                                                  |
| AI <sub>DD</sub> <sup>4</sup>                     | 5                               | mA typ                        |                                                                                                                  |
| DI <sub>DD</sub> <sup>4</sup>                     | 2.5                             | mA typ                        |                                                                                                                  |
| I <sub>VCO</sub> <sup>4, 5</sup>                  | 12.0                            | mA typ                        | I <sub>CORE</sub> = 5 mA                                                                                         |
| I <sub>RFOUT</sub> <sup>4</sup>                   | 3.5 to 11.0                     | mA typ                        | RF output stage is programmable                                                                                  |
| Low Power Sleep Mode <sup>4</sup>                 | 7                               | $\mu\text{A}$ typ             |                                                                                                                  |
| <b>RF OUTPUT CHARACTERISTICS<sup>5</sup></b>      |                                 |                               |                                                                                                                  |
| Maximum VCO Output Frequency                      | 400                             | MHz                           | I <sub>CORE</sub> = 5 mA; depending on L1 and L2; see the Choosing the Correct Inductance Value section          |
| Minimum VCO Output Frequency                      | 65                              | MHz                           |                                                                                                                  |
| VCO Output Frequency                              | 90/108                          | MHz min/MHz max               | L1, L2 = 270 nH; see the Choosing the Correct Inductance Value section for other frequency values                |
| VCO Frequency Range                               | 1.2                             | Ratio                         | $f_{MAX}/f_{MIN}$                                                                                                |
| VCO Sensitivity                                   | 2                               | MHz/V typ                     | L1, L2 = 270 nH; see the Choosing the Correct Inductance Value section for other sensitivity values              |
| Lock Time <sup>6</sup>                            | 400                             | $\mu\text{s}$ typ             | To within 10 Hz of final frequency                                                                               |

# ADF4360-9

| Parameter                                                          | B Version                           | Unit                                                               | Conditions/Comments                                                                                                                                         |
|--------------------------------------------------------------------|-------------------------------------|--------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Frequency Pushing (Open Loop)                                      | 0.24                                | MHz/V typ                                                          | Into 2.00 VSWR load                                                                                                                                         |
| Frequency Pulling (Open Loop)                                      | 10                                  | Hz typ                                                             |                                                                                                                                                             |
| Harmonic Content (Second)                                          | −16                                 | dBc typ                                                            |                                                                                                                                                             |
| Harmonic Content (Third)                                           | −21                                 | dBc typ                                                            |                                                                                                                                                             |
| Output Power <sup>5, 7</sup>                                       | −9/0                                | dBm typ                                                            |                                                                                                                                                             |
| Output Power <sup>5, 8</sup>                                       | −14/−9                              | dBm typ                                                            | Using tuned load, programmable in 3 dB steps; see Figure 35                                                                                                 |
| Output Power Variation                                             | ±3                                  | dB typ                                                             | Using 50 Ω resistors to V <sub>VCO</sub> , programmable in 3 dB steps; see Figure 33                                                                        |
| VCO Tuning Range                                                   | 1.25/2.5                            | V min/V max                                                        |                                                                                                                                                             |
| VCO NOISE CHARACTERISTICS                                          |                                     |                                                                    |                                                                                                                                                             |
| VCO Phase Noise Performance <sup>9,10</sup>                        | −91<br>−117<br>−139<br>−140<br>−147 | dBc/Hz typ<br>dBc/Hz typ<br>dBc/Hz typ<br>dBc/Hz typ<br>dBc/Hz typ | @ 10 kHz offset from carrier<br>@ 100 kHz offset from carrier<br>@ 1 MHz offset from carrier<br>@ 3 MHz offset from carrier<br>@ 10 MHz offset from carrier |
| Normalized In-Band Phase Noise <sup>10, 11</sup>                   | −218                                | dBc/Hz typ                                                         | @ 1 kHz offset from carrier<br>Measured at RF <sub>OUTA</sub>                                                                                               |
| In-Band Phase Noise <sup>10, 11</sup>                              | −110                                | dBc/Hz typ                                                         |                                                                                                                                                             |
| RMS Integrated Jitter <sup>12</sup>                                | 1.4                                 | ps typ                                                             |                                                                                                                                                             |
| Spurious Signals Due to PFD Frequency <sup>13</sup>                | −75                                 | dBc typ                                                            |                                                                                                                                                             |
| DIVOUT CHARACTERISTICS <sup>12</sup>                               |                                     |                                                                    |                                                                                                                                                             |
| Integrated Jitter Performance<br>(Integrated from 100 Hz to 1 GHz) |                                     |                                                                    | VCO frequency = 320 MHz to 380 MHz                                                                                                                          |
| DIVOUT = 180 MHz                                                   | 1.4                                 | ps rms                                                             | A = 2, A output selected                                                                                                                                    |
| DIVOUT = 95 MHz                                                    | 1.4                                 | ps rms                                                             | A = 2, A/2 output selected                                                                                                                                  |
| DIVOUT = 80 MHz                                                    | 1.4                                 | ps rms                                                             | A = 2, A/2 output selected                                                                                                                                  |
| DIVOUT = 52 MHz                                                    | 1.4                                 | ps rms                                                             | A = 3, A/2 output selected (VCO = 312 MHz, PFD = 1.6 MHz)                                                                                                   |
| DIVOUT = 45 MHz                                                    | 1.4                                 | ps rms                                                             | A = 4, A/2 output selected                                                                                                                                  |
| DIVOUT = 10 MHz                                                    | 1.6                                 | ps rms                                                             | A = 18, A/2 output selected (VCO = 360 MHz, PFD = 1.6 MHz)                                                                                                  |
| DIVOUT Duty Cycle                                                  |                                     |                                                                    |                                                                                                                                                             |
| A Output                                                           | 1/A × 100                           | % typ                                                              | Divide-by-A selected                                                                                                                                        |
| A/2 Output                                                         | 50                                  | % typ                                                              | Divide-by-A/2 selected                                                                                                                                      |

<sup>1</sup> Operating temperature range is -40°C to +85°C.

<sup>2</sup> Guaranteed by design. Sample tested to ensure compliance.

<sup>3</sup>  $I_{CP}$  is internally modified to maintain constant loop gain over the frequency range.

<sup>4</sup>  $T_A = 25^\circ\text{C}$ ;  $AV_{DD} = DV_{DD} = V_{VCO} = 3.3\text{ V}$ .

<sup>5</sup> Unless otherwise stated, these characteristics are guaranteed for VCO core power = 5 mA. L1, L2 = 270 nH, 470  $\Omega$  resistors to GND in parallel with L1, L2.

<sup>6</sup> Jumping from 90 MHz to 108 MHz. PFD frequency = 200 kHz; loop bandwidth = 10 kHz.

<sup>7</sup> For more detail on using tuned loads, see the Output Matching section.

<sup>8</sup> Using 50  $\Omega$  resistors to  $V_{VCO}$  into a 50  $\Omega$  load.

<sup>9</sup> The noise of the VCO is measured in open-loop conditions. L1, L2 = 56 nH.

<sup>10</sup> The phase noise is measured with the EVAL-ADF4360-9EBZ1 evaluation board and the Agilent E5052A signal source analyzer.

<sup>11</sup>  $f_{REFIN} = 10\text{ MHz}$ ;  $f_{PFD} = 1\text{ MHz}$ ;  $N = 360$ ; loop B/W = 40 kHz. The normalized phase noise floor is estimated by measuring the in-band phase noise at the output of the VCO and subtracting  $20\log N$  (where N is the N divider value) and  $10\log f_{PFD}$ .  $PN_{SYNTH} = PN_{TOT} - 10\log f_{PFD} - 20\log N$ .

<sup>12</sup> The jitter is measured with the EVAL-ADF4360-9EBZ1 evaluation board and the Agilent E5052A signal source analyzer. A low noise TCXO provides the  $REF_{IN}$  for the synthesizer, and the jitter is measured over the instrument's jitter measurement bandwidth.  $f_{REFIN} = 10\text{ MHz}$ ;  $f_{PFD} = 1\text{ MHz}$ ;  $N = 360$ ; loop BW = 40 kHz, unless otherwise noted.

<sup>13</sup> The spurious signals are measured with the EVAL-ADF4360-9EBZ1 evaluation board and the Agilent E5052A signal source analyzer. The spectrum analyzer provides the  $REF_{IN}$  for the synthesizer;  $f_{REFIN} = 10\text{ MHz}$  @ 0 dBm.  $f_{REFIN} = 10\text{ MHz}$ ;  $f_{PFD} = 1\text{ MHz}$ ;  $N = 360$ ; loop BW = 40 kHz.

**TIMING CHARACTERISTICS<sup>1</sup>**

$AV_{DD} = DV_{DD} = V_{VCO} = 3.3 \text{ V} \pm 10\%$ ;  $AGND = DGND = 0 \text{ V}$ ; 1.8 V and 3 V logic levels used;  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

**Table 2.**

| Parameter | Limit at $T_{MIN}$ to $T_{MAX}$ (B Version) | Unit   | Test Conditions/Comments |
|-----------|---------------------------------------------|--------|--------------------------|
| $t_1$     | 20                                          | ns min | LE setup time            |
| $t_2$     | 10                                          | ns min | DATA to CLK setup time   |
| $t_3$     | 10                                          | ns min | DATA to CLK hold time    |
| $t_4$     | 25                                          | ns min | CLK high duration        |
| $t_5$     | 25                                          | ns min | CLK low duration         |
| $t_6$     | 10                                          | ns min | CLK to LE setup time     |
| $t_7$     | 20                                          | ns min | LE pulse width           |

<sup>1</sup> Refer to the Power-Up section for the recommended power-up procedure for this device.

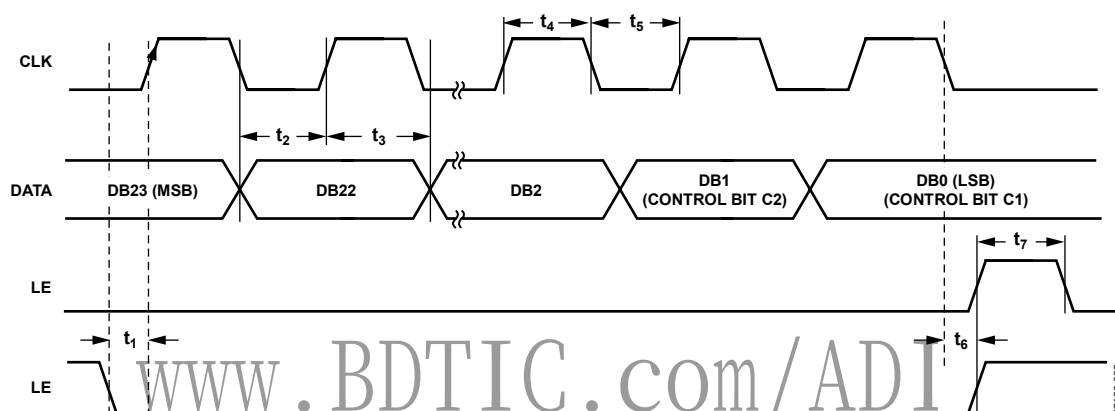


Figure 2. Timing Diagram

07138-002

## ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$ , unless otherwise noted.

Table 3.

| Parameter                             | Rating                     |
|---------------------------------------|----------------------------|
| $AV_{DD}$ to GND <sup>1</sup>         | –0.3 V to +3.9 V           |
| $AV_{DD}$ to $DV_{DD}$                | –0.3 V to +0.3 V           |
| $V_{VCO}$ to GND                      | –0.3 V to +3.9 V           |
| $V_{VCO}$ to $AV_{DD}$                | –0.3 V to +0.3 V           |
| Digital Input/Output Voltage to GND   | –0.3 V to $V_{DD} + 0.3$ V |
| Analog Input/Output Voltage to GND    | –0.3 V to $V_{DD} + 0.3$ V |
| $REF_{IN}$ to GND                     | –0.3 V to $V_{DD} + 0.3$ V |
| Operating Temperature Range           | –40°C to +85°C             |
| Storage Temperature Range             | –65°C to +150°C            |
| Maximum Junction Temperature          | 150°C                      |
| LFCSP $\theta_{JA}$ Thermal Impedance |                            |
| Paddle Soldered                       | 50°C/W                     |
| Paddle Not Soldered                   | 88°C/W                     |
| Lead Temperature, Soldering           |                            |
| Vapor Phase (60 sec)                  | 215°C                      |
| Infrared (15 sec)                     | 220°C                      |

<sup>1</sup> GND = CPGND = AGND = DGND = 0 V.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

This device is a high performance RF integrated circuit with an ESD rating of <1 kV, and it is ESD sensitive. Proper precautions should be taken for handling and assembly.

### TRANSISTOR COUNT

The transistor count is 12,543 (CMOS) and 700 (bipolar).

### ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

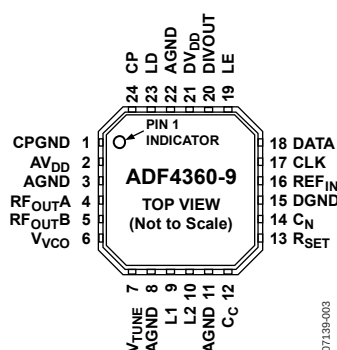


Figure 3. Pin Configuration

Table 4. Pin Function Descriptions

| Pin No.      | Mnemonic           | Description                                                                                                                                                                                                                                                                                                                                                   |
|--------------|--------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1            | CPGND              | Charge Pump Ground. This is the ground return path for the charge pump.                                                                                                                                                                                                                                                                                       |
| 2            | AV <sub>DD</sub>   | Analog Power Supply. This ranges from 3.0 V to 3.6 V. Decoupling capacitors to the analog ground plane should be placed as close as possible to this pin. AV <sub>DD</sub> must have the same value as DV <sub>DD</sub> .                                                                                                                                     |
| 3, 8, 11, 22 | AGND               | Analog Ground. This is the ground return path of the prescaler and VCO.                                                                                                                                                                                                                                                                                       |
| 4            | RF <sub>OUTA</sub> | VCO Output. The output level is programmable from 0 dBm to –9 dBm. See the Output Matching section for a description of the various output stages.                                                                                                                                                                                                            |
| 5            | RF <sub>OUTB</sub> | VCO Complementary Output. The output level is programmable from 0 dBm to –9 dBm. See the Output Matching section for a description of the various output stages.                                                                                                                                                                                              |
| 6            | V <sub>VCO</sub>   | Power Supply for the VCO. This ranges from 3.0 V to 3.6 V. Decoupling capacitors to the analog ground plane should be placed as close as possible to this pin. V <sub>VCO</sub> must have the same value as AV <sub>DD</sub> .                                                                                                                                |
| 7            | V <sub>TUNE</sub>  | Control Input to the VCO. This voltage determines the output frequency and is derived from filtering the CP output voltage.                                                                                                                                                                                                                                   |
| 9            | L1                 | An external inductor to AGND should be connected to this pin to set the ADF4360-9 output frequency. L1 and L2 need to be the same value. A 470 Ω resistor should be added in parallel to AGND.                                                                                                                                                                |
| 10           | L2                 | An external inductor to AGND should be connected to this pin to set the ADF4360-9 output frequency. L1 and L2 need to be the same value. A 470 Ω resistor should be added in parallel to AGND.                                                                                                                                                                |
| 12           | C <sub>C</sub>     | Internal Compensation Node. This pin must be decoupled to ground with a 10 nF capacitor.                                                                                                                                                                                                                                                                      |
| 13           | R <sub>SET</sub>   | Connecting a resistor between this pin and CPGND sets the maximum charge pump output current for the synthesizer. The nominal voltage potential at the R <sub>SET</sub> pin is 0.6 V. The relationship between I <sub>CP</sub> and R <sub>SET</sub> is<br>$I_{CPmax} = 11.75/R_{SET}$ For example, R <sub>SET</sub> = 4.7 kΩ and I <sub>CPmax</sub> = 2.5 mA. |
| 14           | C <sub>N</sub>     | Internal Compensation Node. This pin must be decoupled to V <sub>VCO</sub> with a 10 μF capacitor.                                                                                                                                                                                                                                                            |
| 15           | DGND               | Digital Ground.                                                                                                                                                                                                                                                                                                                                               |
| 16           | REF <sub>IN</sub>  | Reference Input. This is a CMOS input with a nominal threshold of V <sub>DD</sub> /2 and a dc equivalent input resistance of 100 kΩ (see Figure 16). This input can be driven from a TTL or CMOS crystal oscillator, or it can be ac-coupled.                                                                                                                 |
| 17           | CLK                | Serial Clock Input. This serial clock is used to clock in the serial data to the registers. The data is latched into the 24-bit shift register on the CLK rising edge. This input is a high impedance CMOS input.                                                                                                                                             |
| 18           | DATA               | Serial Data Input. The serial data is loaded MSB first with the two LSBs being the control bits. This input is a high impedance CMOS input.                                                                                                                                                                                                                   |
| 19           | LE                 | Load Enable, CMOS Input. When LE goes high, the data stored in the shift registers is loaded into one of the four latches, and the relevant latch is selected using the control bits.                                                                                                                                                                         |
| 20           | DIVOUT             | This output allows the user to select VCO frequency divided by A or VCO frequency divided by 2A. Alternatively, the scaled RF, or the scaled reference frequency, can be accessed externally through this output.                                                                                                                                             |
| 21           | DV <sub>DD</sub>   | Digital Power Supply. This ranges from 3.0 V to 3.6 V. Decoupling capacitors to the digital ground plane should be placed as close as possible to this pin. DV <sub>DD</sub> must have the same value as AV <sub>DD</sub> .                                                                                                                                   |
| 23           | LD                 | Lock Detect. The output on this pin is logic high to indicate that the part is in lock. Logic low indicates loss of lock.                                                                                                                                                                                                                                     |
| 24           | CP                 | Charge Pump Output. When enabled, this provides ±I <sub>CP</sub> to the external loop filter, which in turn drives the internal VCO.                                                                                                                                                                                                                          |

# TYPICAL PERFORMANCE CHARACTERISTICS

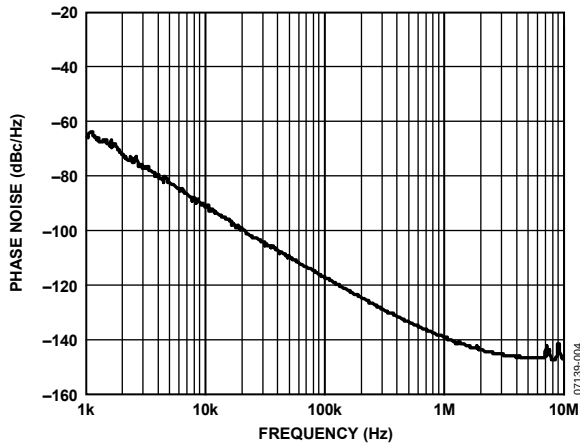


Figure 4. Open-Loop VCO Phase Noise at 218 MHz, L1, L2 = 56 nH

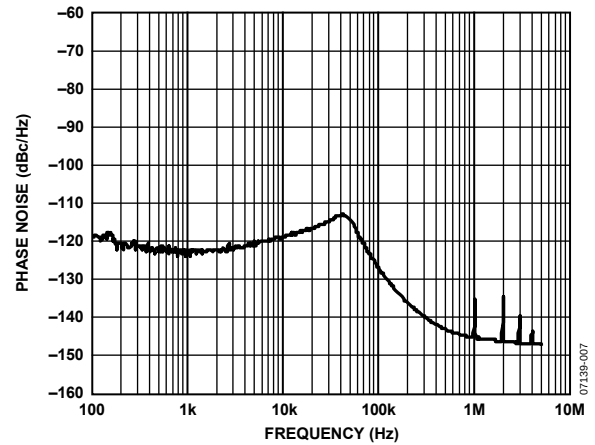


Figure 7. DIVOUT Phase Noise, 95 MHz, VCO = 380 MHz, PFD Frequency = 1 MHz, Loop Bandwidth = 40 kHz, Jitter = 1.3 ps, Divide-by-A/2 Selected, A = 2

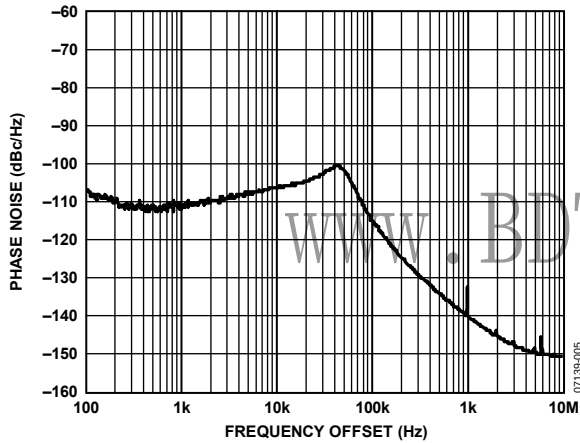


Figure 5. VCO Phase Noise, 360 MHz, 1 MHz PFD, 40 kHz Loop Bandwidth, RMS Jitter = 1.4 ps

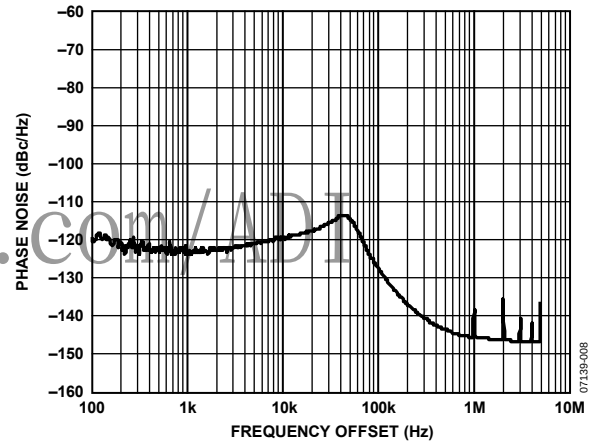


Figure 8. DIVOUT Phase Noise, 80 MHz, VCO = 320 MHz, PFD Frequency = 1 MHz, Loop Bandwidth = 40 kHz, Jitter = 1.3 ps, Divide-by-A/2 Selected, A = 2

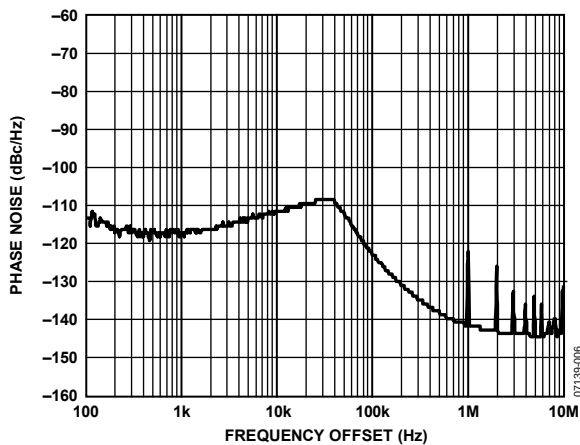


Figure 6. DIVOUT Phase Noise, 180 MHz, VCO = 360 MHz, PFD Frequency = 1 MHz, Loop Bandwidth = 40 kHz, Jitter = 1.3 ps, Divide-by-A Selected, A = 2

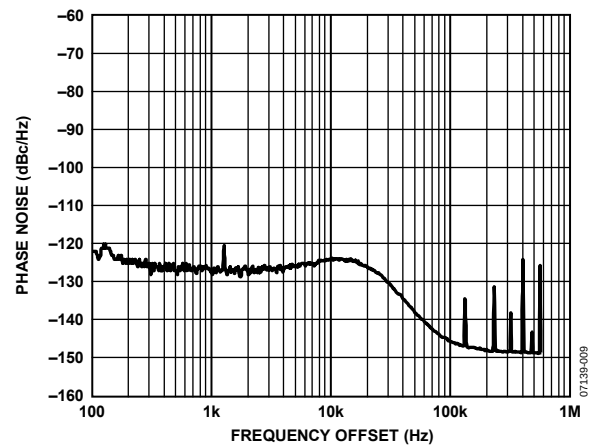


Figure 9. DIVOUT Phase Noise, 52 MHz, VCO = 312 MHz, PFD Frequency = 1.6 MHz, Loop Bandwidth = 40 kHz, Jitter = 1.4 ps, Divide-by-A/2 Selected, A = 3

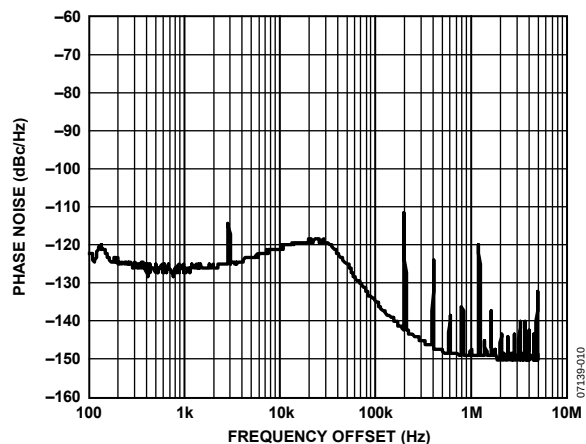


Figure 10. DIVOUT Phase Noise, 45 MHz, VCO = 360 MHz, PFD Frequency = 1.6 MHz, Loop Bandwidth = 60 kHz, Jitter = 1.4 ps, Divide-by-A/2 Selected, A = 2

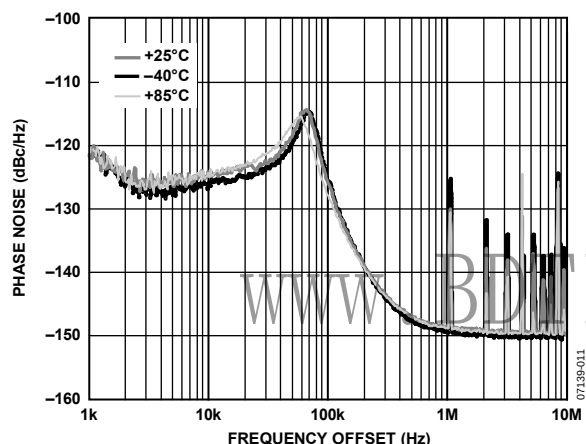


Figure 11. DIVOUT Phase Noise over Temperature, 52 MHz, VCO = 312 MHz, PFD Frequency = 1 MHz, Loop Bandwidth = 60 kHz, Divide-by-A/2 Selected, A = 3

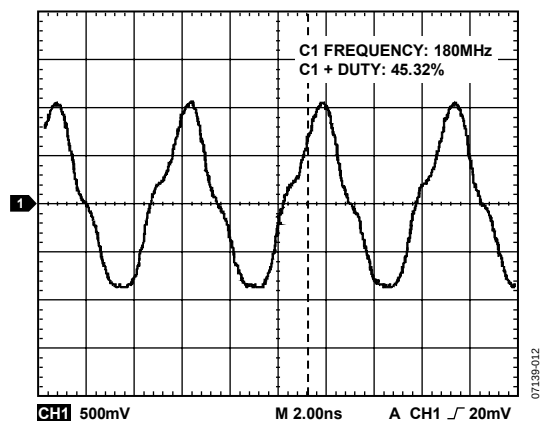


Figure 12. DIVOUT 180 MHz Waveform, VCO = 360 MHz, Divide-by-A Selected, A = 2, Duty Cycle = ~50%

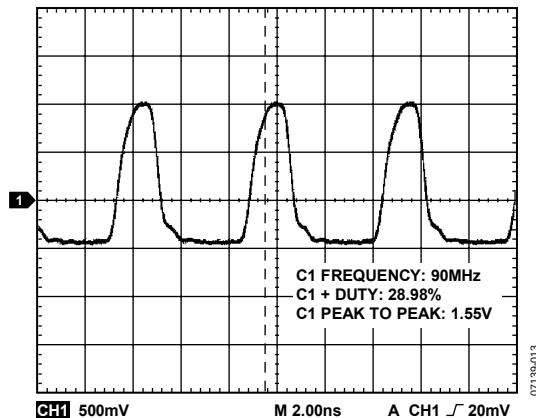


Figure 13. DIVOUT 90 MHz Waveform, VCO = 360 MHz, Divide-by-A Selected, A = 4, Duty Cycle = ~25%

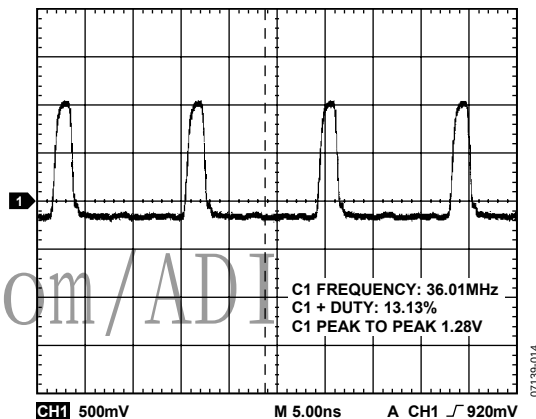


Figure 14. DIVOUT 36 MHz Waveform, VCO = 360 MHz, Divide-by-A Selected, A = 10, Duty Cycle = ~10%

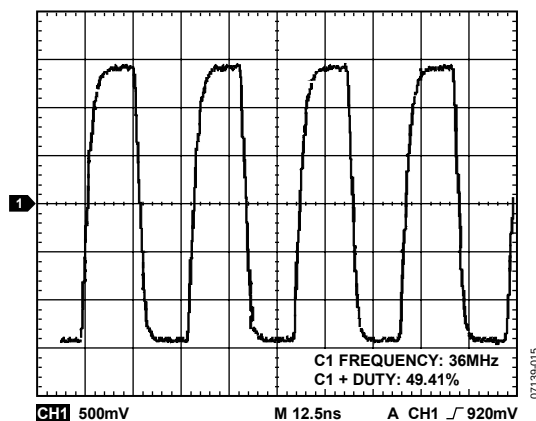


Figure 15. DIVOUT 36 MHz Waveform, VCO = 360 MHz, Divide-by-A/2 Selected, A = 5, Duty Cycle = ~50%

## CIRCUIT DESCRIPTION

### REFERENCE INPUT SECTION

The reference input stage is shown in Figure 16. SW1 and SW2 are normally closed switches, and SW3 is normally open. When power-down is initiated, SW3 is closed, and SW1 and SW2 are opened. This ensures that there is no loading of the REF<sub>IN</sub> pin at power-down.

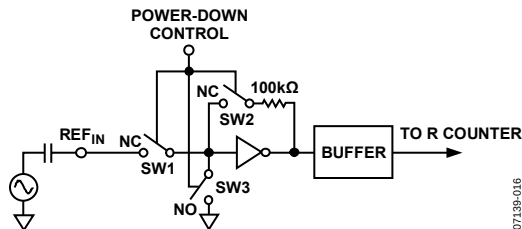


Figure 16. Reference Input Stage

### N COUNTER

The CMOS N counter allows a wide division ratio in the PLL feedback counter. The counters are specified to work when the VCO output is 400 MHz or less. To avoid confusion, this is referred to as the B counter. It makes it possible to generate output frequencies that are spaced only by the reference frequency divided by R. The VCO frequency equation is

$$f_{VCO} = B \times f_{REFIN}/R$$

where:

$f_{VCO}$  is the output frequency of the VCO.

$B$  is the preset divide ratio of the binary 13-bit counter (3 to 8191).

$f_{REFIN}$  is the external reference frequency oscillator.

### R COUNTER

The 14-bit R counter allows the input reference frequency to be divided down to produce the reference clock to the phase frequency detector (PFD). Division ratios from 1 to 16,383 are allowed.

### PFD AND CHARGE PUMP

The PFD takes inputs from the R counter and N counter ( $N = B$ ) and produces an output proportional to the phase and frequency difference between them. Figure 17 is a simplified schematic. The PFD includes a programmable delay element that controls the width of the antibacklash pulse. This pulse ensures that there is no dead zone in the PFD transfer function and minimizes phase noise and reference spurs. Two bits in the R counter latch, ABP2 and ABP1, control the width of the pulse (see Figure 25).

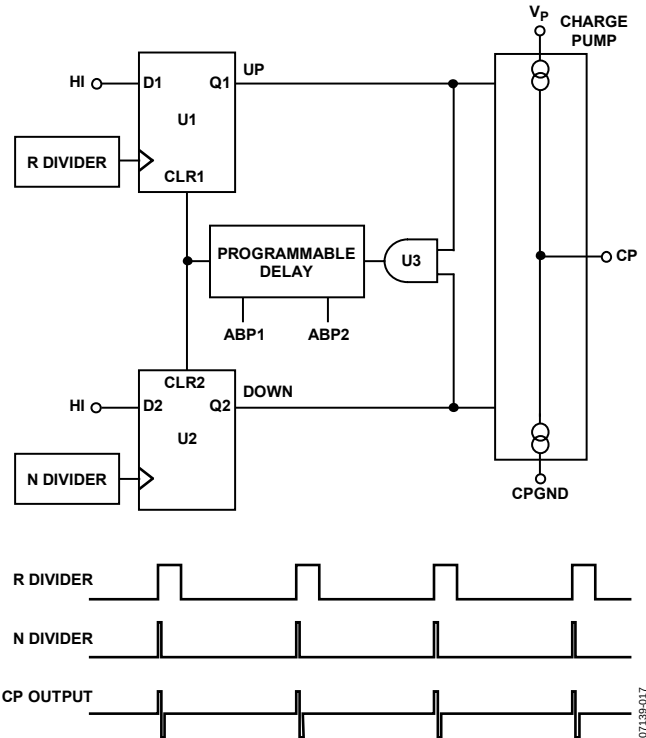


Figure 17. PFD Simplified Schematic and Timing (In Lock)

### LOCK DETECT

The LD pin outputs a lock detect signal. Digital lock detect is active high. When lock detect precision (LDP) in the R counter latch is set to 0, digital lock detect is set high when the phase error on three consecutive phase detector cycles is <15 ns.

When LDP is set to 1, five consecutive cycles of <15 ns phase error are required to set the lock detect. It stays set high until a phase error of >25 ns is detected on any subsequent PD cycle.

### INPUT SHIFT REGISTER

The digital section of the ADF4360 family includes a 24-bit input shift register, a 14-bit R counter, and an 18-bit N counter, comprising a 5-bit A counter and a 13-bit B counter. Data is clocked into the 24-bit shift register on each rising edge of CLK. The data is clocked in MSB first. Data is transferred from the shift register to one of four latches on the rising edge of LE. The destination latch is determined by the state of the two control bits (C2, C1) in the shift register. The two LSBs, DB1 and DB0, are shown in Figure 2.

The truth table for these bits is shown in Table 5. Figure 22 shows a summary of how the latches are programmed. Note that the test modes latch is used for factory testing and should not be programmed by the user.

Table 5. C2 and C1 Truth Table

| Control Bits |    | Data Latch    |
|--------------|----|---------------|
| C2           | C1 |               |
| 0            | 0  | Control       |
| 0            | 1  | R Counter     |
| 1            | 0  | N Counter (B) |
| 1            | 1  | Test Modes    |

## VCO

The VCO core in the ADF4360 family uses eight overlapping bands, as shown in Figure 18, to allow a wide frequency range to be covered without a large VCO sensitivity ( $K_V$ ) and resultant poor phase noise and spurious performance.

The correct band is chosen automatically by the band select logic at power-up or whenever the N counter latch is updated. It is important that the correct write sequence be followed at power-up. The correct write sequence is as follows:

1. R Counter Latch
2. Control Latch
3. N Counter Latch

During band selection, which takes five PFD cycles, the VCO  $V_{TUNE}$  is disconnected from the output of the loop filter and connected to an internal reference voltage.

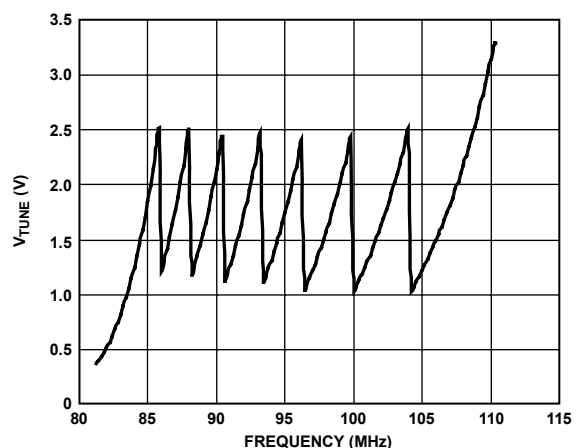


Figure 18.  $V_{TUNE}$ , ADF4360-9, L1 and L2 = 270 nH vs. Frequency

The R counter output is used as the clock for the band select logic and should not exceed 1 MHz. A programmable divider is provided at the R counter input to allow division by 1, 2, 4, or 8 and is controlled by the BSC1 bit and the BSC2 bit in the R counter latch. Where the required PFD frequency exceeds 1 MHz, the divide ratio should be set to allow enough time for correct band selection. For many applications, it is usually best to set this to 8.

After band selection, normal PLL action resumes. The value of  $K_V$  is determined by the value of the inductors used (see the Choosing the Correct Inductance Value section). The ADF4360 family contains linearization circuitry to minimize any variation of the product of  $I_{CG}$  and  $K_V$ .

The operating current in the VCO core is programmable in four steps: 2.5 mA, 5 mA, 7.5 mA, and 10 mA. This is controlled by the PC1 bit and the PC2 bit in the control latch.

It is strongly recommended that only the 5 mA setting be used. However, in applications requiring a low VCO frequency, the high temperature coefficient of some inductors may lead to the VCO tuning voltage varying as temperature changes. The 7.5 mA VCO core power setting shows less tuning voltage variation over temperature in these applications and can be used, provided that 240  $\Omega$  resistors are used in parallel with Pin 9 and Pin 10, instead of the default 470  $\Omega$ .

## OUTPUT STAGE

The RF<sub>OUTA</sub> and RF<sub>OUTB</sub> pins of the ADF4360 family are connected to the collectors of an NPN differential pair driven by buffered outputs of the VCO, as shown in Figure 19. To allow the user to optimize the power dissipation vs. the output power requirements, the tail current of the differential pair is programmable via Bit PL1 and Bit PL2 in the control latch. Four current levels can be set: 3.5 mA, 5 mA, 7.5 mA, and 11 mA. These levels give output power levels of -9 dBm, -6 dBm, -3 dBm, and 0 dBm, respectively, using the correct shunt inductor to V<sub>DD</sub> and ac coupling into a 50 Ω load. Alternatively, both outputs can be combined in a 1 + 1:1 transformer or a 180° microstrip coupler (see the Output Matching section).

Another feature of the ADF4360 family is that the supply current to the RF output stage is shut down until the part achieves lock, as measured by the digital lock detect circuitry. This is enabled by the mute-till-lock detect (MTLD) bit in the control latch.

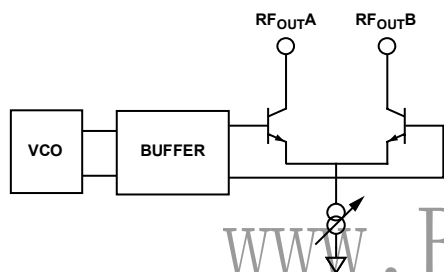


Figure 19. RF Output Stage

## DIVOUT STAGE

The output multiplexer on the ADF4360 family allows the user to access various internal points on the chip. The state of DIVOUT is controlled by D3, D2, and D1 in the control latch. The full truth table is shown in Figure 23. Figure 20 shows the DIVOUT section in block diagram form.

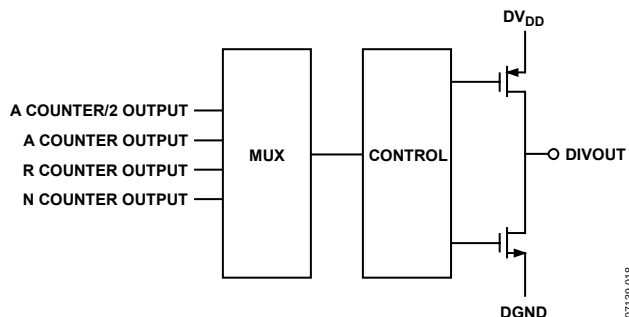


Figure 20. DIVOUT Circuit

The primary use of this pin is to derive the lower frequencies from the VCO by programming various divider values to the auxiliary A divider. Values ranging from 2 to 31 are possible. The duty cycle of this output is 1/A times 100%, with the logic high pulse width equal to the inverse of the VCO frequency. That is,

$$\text{Pulse Width [seconds]} = 1/f_{\text{VCO}} (\text{Frequency [Hz]})$$

See Figure 21 for a graphical description. By selecting the divide-by-2 function, this divided down frequency can in turn be divided by 2 again. This provides a 50% duty cycle in contrast to the A counter output, which may be more suitable for some applications (see Figure 21).

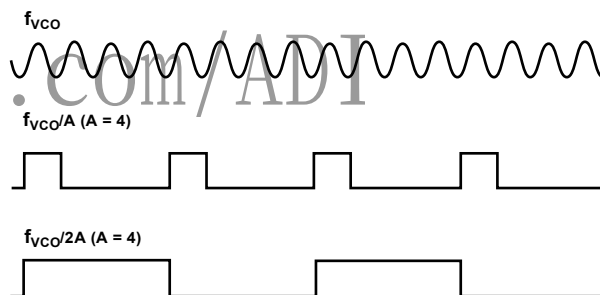


Figure 21. DIVOUT Waveforms

# LATCH STRUCTURE

Figure 22 shows the three on-chip latches for the ADF4360-9. The two LSBs decide which latch is programmed.

CONTROL LATCH

| RESERVED | RESERVED | POWER-DOWN 2 | POWER-DOWN 1 | CURRENT SETTING 2 |      |      | CURRENT SETTING 1 |      |      | OUTPUT POWER LEVEL |      | MUTE-TILL-D | CP GAIN | CP THREE-STATE | PHASE DETECTOR POLARITY | DIVOUT CONTROL |     |     | COUNTER RESET | CORE POWER LEVEL |     | CONTROL BITS |        |
|----------|----------|--------------|--------------|-------------------|------|------|-------------------|------|------|--------------------|------|-------------|---------|----------------|-------------------------|----------------|-----|-----|---------------|------------------|-----|--------------|--------|
| DB23     | DB22     | DB21         | DB20         | DB19              | DB18 | DB17 | DB16              | DB15 | DB14 | DB13               | DB12 | DB11        | DB10    | DB9            | DB8                     | DB7            | DB6 | DB5 | DB4           | DB3              | DB2 | DB1          | DB0    |
| RSV      | RSV      | PD2          | PD1          | CPI6              | CPI5 | CPI4 | CPI3              | CPI2 | CPI1 | PL2                | PL1  | MTLD        | CPG     | CP             | PDP                     | D3             | D2  | D1  | CR            | PC2              | PC1 | C2 (0)       | C1 (0) |

N COUNTER LATCH

| RESERVED | RESERVED | CP GAIN | 13-BIT B COUNTER |      |      |      |      |      |      |      |      |      |      |     |     | RESERVED | 5-BIT DIVOUT |     |     |     |     | CONTROL BITS |        |
|----------|----------|---------|------------------|------|------|------|------|------|------|------|------|------|------|-----|-----|----------|--------------|-----|-----|-----|-----|--------------|--------|
| DB23     | DB22     | DB21    | DB20             | DB19 | DB18 | DB17 | DB16 | DB15 | DB14 | DB13 | DB12 | DB11 | DB10 | DB9 | DB8 | DB7      | DB6          | DB5 | DB4 | DB3 | DB2 | DB1          | DB0    |
| RSV      | RSV      | CPG     | B13              | B12  | B11  | B10  | B9   | B8   | B7   | B6   | B5   | B4   | B3   | B2  | B1  | RSV      | A5           | A4  | A3  | A2  | A1  | C2 (1)       | C1 (0) |

R COUNTER LATCH

| RESERVED | RESERVED | BAND<br>SELECT<br>CLOCK |      | TEST MODE<br>BIT | LOCK<br>DETECT<br>PRECISION | ANTI-<br>BACKLASH<br>PULSE WIDTH | 14-BIT REFERENCE COUNTER |      |      |      |      |      |      |     |     |     |     |     |     |     | CONTROL<br>BITS |        |        |
|----------|----------|-------------------------|------|------------------|-----------------------------|----------------------------------|--------------------------|------|------|------|------|------|------|-----|-----|-----|-----|-----|-----|-----|-----------------|--------|--------|
| DB23     | DB22     | DB21                    | DB20 | DB19             | DB18                        | DB17                             | DB16                     | DB15 | DB14 | DB13 | DB12 | DB11 | DB10 | DB9 | DB8 | DB7 | DB6 | DB5 | DB4 | DB3 | DB2             | DB1    | DB0    |
| RSV      | RSV      | BSC2                    | BSC1 | TMB              | LDP                         | ABP2                             | ABP1                     | R14  | R13  | R12  | R11  | R10  | R9   | R8  | R7  | R6  | R5  | R4  | R3  | R2  | R1              | C2 (0) | C1 (1) |

Figure 22. Latch Structure

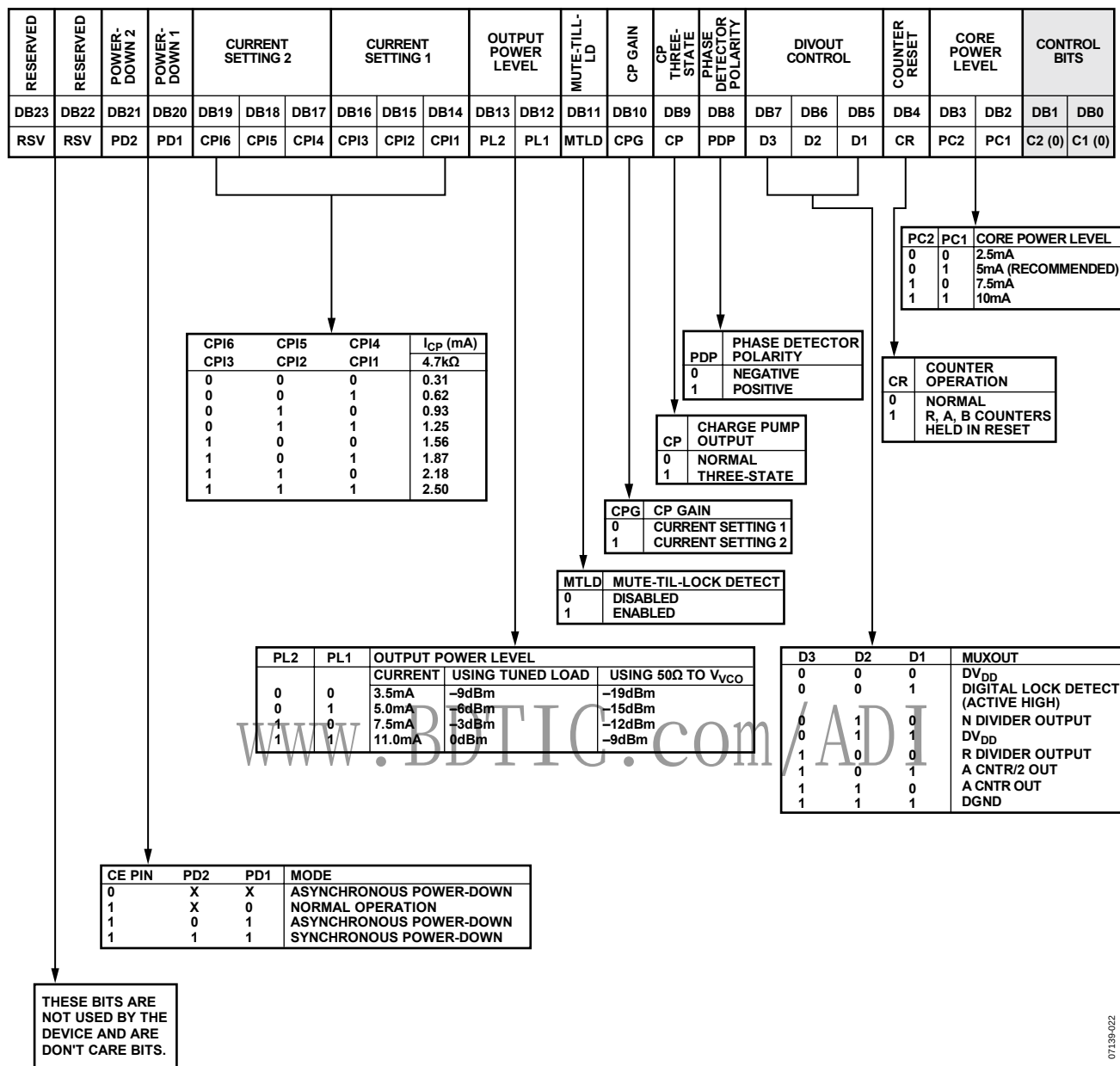


Figure 23. Control Latch

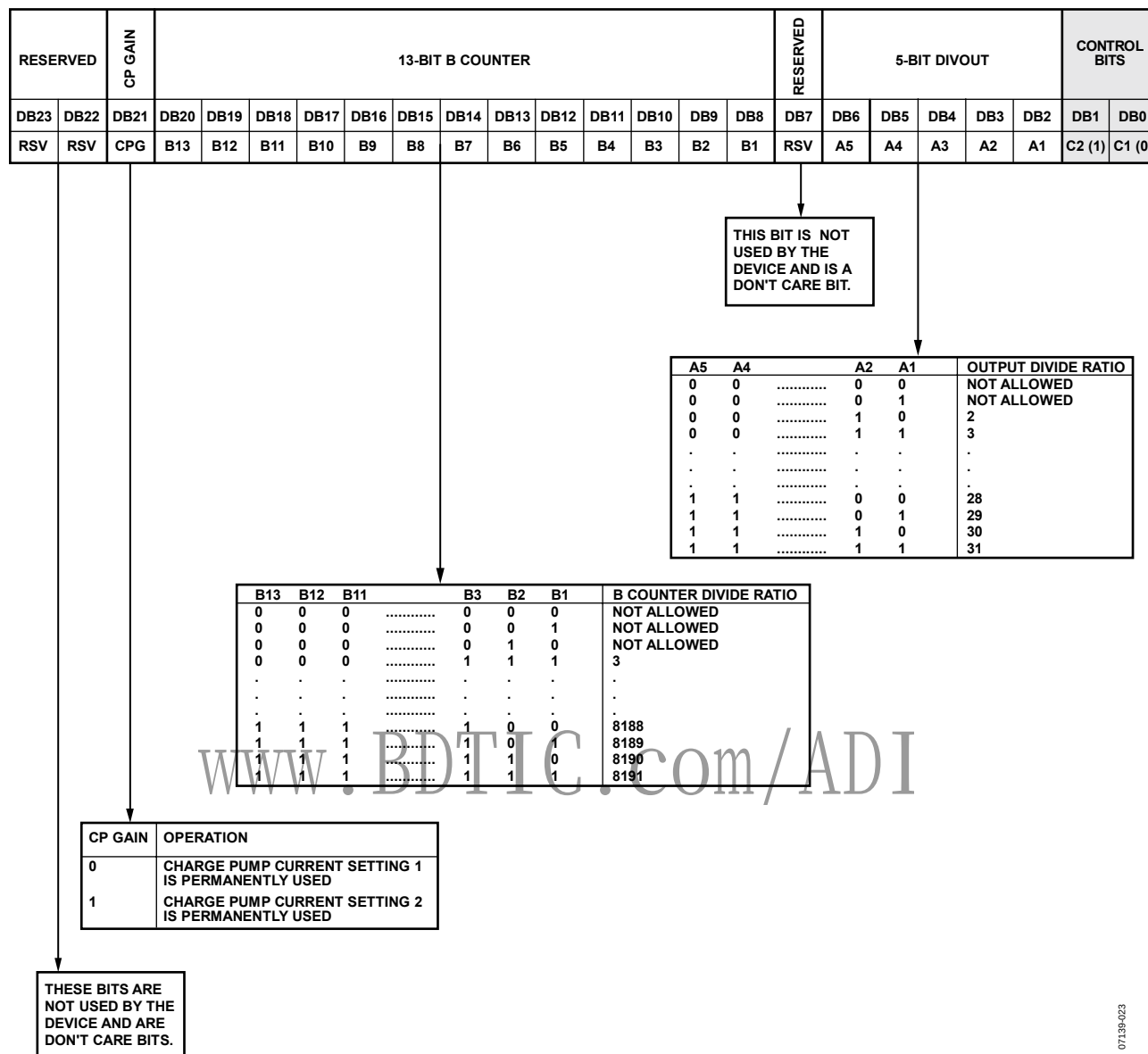


Figure 24. N Counter Latch

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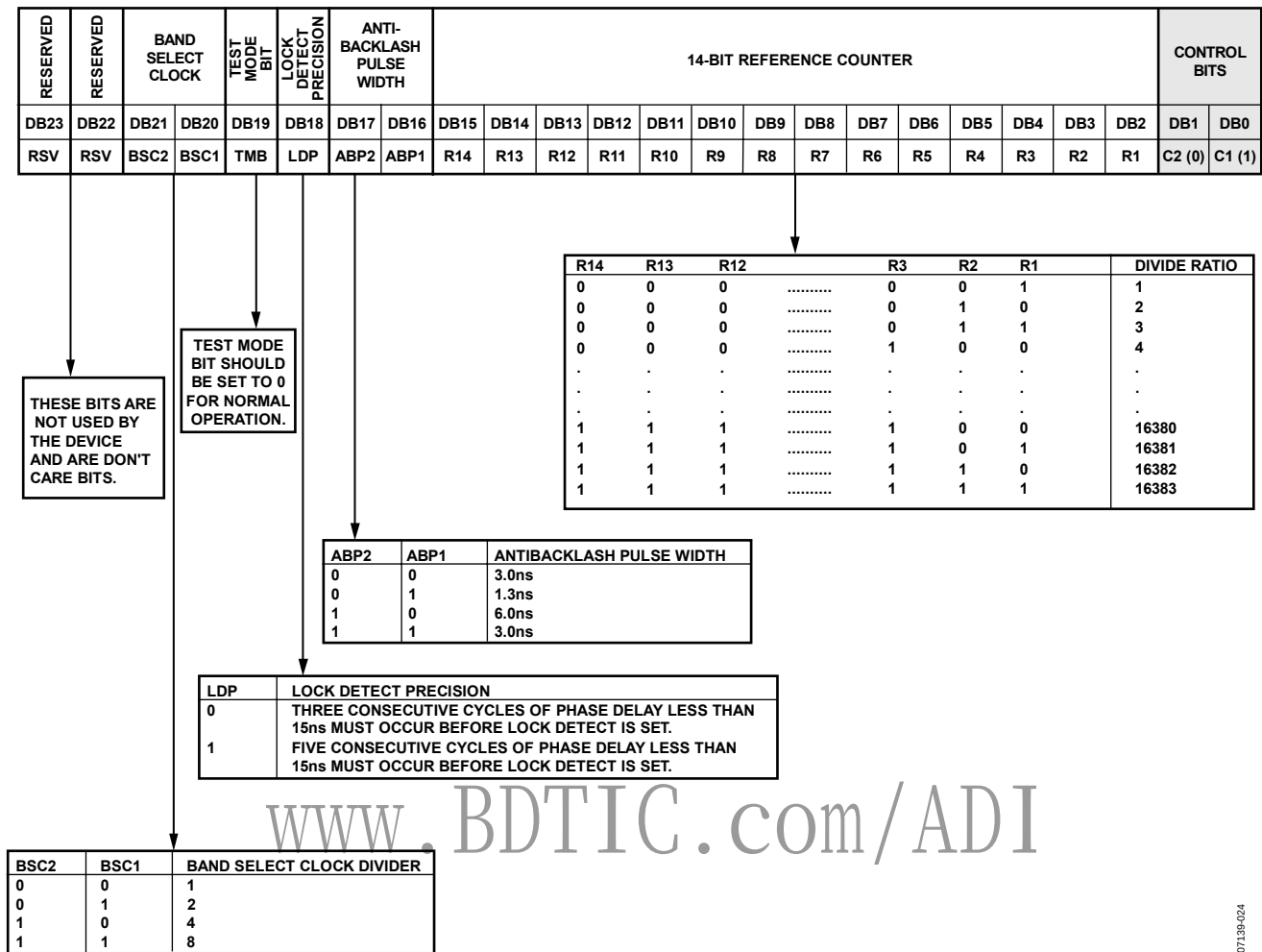


Figure 25. R Counter Latch

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## POWER-UP

### Power-Up Sequence

The correct programming sequence for the ADF4360-9 after power-up is as follows:

1. R Counter Latch
2. Control Latch
3. N Counter Latch

### Initial Power-Up

Initial power-up refers to programming the part after the application of voltage to the  $AV_{DD}$ ,  $DV_{DD}$ , and  $V_{CO}$  pins. On initial power-up, an interval is required between programming the control latch and programming the N counter latch. This interval is necessary to allow the transient behavior of the ADF4360-9 during initial power-up to settle.

During initial power-up, a write to the control latch powers up the part, and the bias currents of the VCO begin to settle. If these currents have not settled to within 10% of their steady-state value, and if the N counter latch is then programmed, the VCO may not oscillate at the desired frequency, which does not allow the band select logic to choose the correct frequency band, and the ADF4360-9 may not achieve lock. If the recommended interval is inserted, and the N counter latch is programmed, the band select logic can choose the correct frequency band, and the part locks to the correct frequency.

The duration of this interval is affected by the value of the capacitor on the  $C_N$  pin (Pin 14). This capacitor is used to reduce the close-in noise of the ADF4360-9 VCO. The recommended value of this capacitor is 10  $\mu F$ . Using this value requires an interval of  $\geq 15$  ms between the latching in of the control latch bits and latching in of the N counter latch bits. If a shorter delay is required, the capacitor can be reduced. A slight phase noise penalty is incurred by this change, which is further explained in Table 6.

Table 6.  $C_N$  Capacitance vs. Interval and Phase Noise

| $C_N$ Value | Recommended Interval Between Control Latch and N Counter Latch | Open-Loop Phase Noise @ 10 kHz Offset |                      |                      |
|-------------|----------------------------------------------------------------|---------------------------------------|----------------------|----------------------|
|             |                                                                | L1 and L2 = 18.0 nH                   | L1 and L2 = 110.0 nH | L1 and L2 = 560.0 nH |
| 10 $\mu F$  | $\geq 15$ ms                                                   | -100 dBc/Hz                           | -97 dBc/Hz           | -99 dBc/Hz           |
| 440 nF      | $\geq 600$ $\mu s$                                             | -99 dBc/Hz                            | -96 dBc/Hz           | -98 dBc/Hz           |

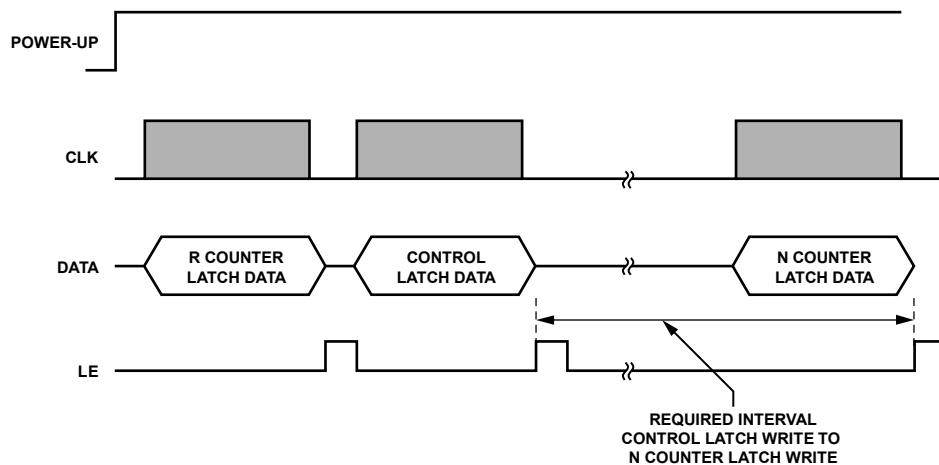


Figure 26. Power-Up Timing

**Software Power-Up/Power-Down**

If the part is powered down via the software (using the control latch) and powered up again without any change to the N counter latch during power-down, the part locks at the correct frequency because the part is already in the correct frequency band. The lock time depends on the value of capacitance on the  $C_N$  pin, which is <15 ms for 10  $\mu$ F capacitance. The smaller capacitance of 440 nF on this pin enables lock times of <600  $\mu$ s.

The N counter value cannot be changed while the part is in power-down because the part may not lock to the correct frequency on power-up. If it is updated, the correct programming sequence for the part after power-up is to the R counter latch, followed by the control latch, and finally the N counter latch, with the required interval between the control latch and N counter latch, as described in the Initial Power-Up section.

**CONTROL LATCH**

With (C2, C1) = (0, 0), the control latch is programmed. Figure 23 shows the input data format for programming the control latch.

**Power-Down**

DB21 (PD2) and DB20 (PD1) provide programmable power-down modes.

In the programmed asynchronous power-down, the device powers down immediately after latching a 1 into Bit PD1, with the condition that PD2 is loaded with a 0. In the programmed synchronous power-down, the device power-down is gated by the charge pump to prevent unwanted frequency jumps. Once the power-down is enabled by writing a 1 into Bit PD1 (on the condition that a 1 is also loaded in PD2), the device goes into power-down on the second rising edge of the R counter output, after LE goes high. When a power-down is activated (either synchronous or asynchronous mode), the following events occur:

- All active dc current paths are removed.
- The R, N, and timeout counters are forced to their load state conditions.
- The charge pump is forced into three-state mode.
- The digital lock detect circuitry is reset.
- The RF outputs are debiased to a high impedance state.
- The reference input buffer circuitry is disabled.
- The input register remains active and capable of loading and latching data.

**Charge Pump Currents**

CPI3, CPI2, and CPI1 in the ADF4360 family determine Current Setting 1. CPI6, CPI5, and CPI4 determine Current Setting 2 (see the truth table in Figure 23).

**Output Power Level**

Bit PL1 and Bit PL2 set the output power level of the VCO (see the truth table in Figure 23).

**Mute-Till-Lock Detect**

DB11 of the control latch in the ADF4360 family is the mute-till-lock detect bit. This function, when enabled, ensures that the RF outputs are not switched on until the PLL is locked.

**CP Gain**

DB10 of the control latch in the ADF4360 family is the charge pump gain bit. When it is programmed to 1, Current Setting 2 is used. When programmed to 0, Current Setting 1 is used.

**Charge Pump Three-State**

This bit (DB9) puts the charge pump into three-state mode when programmed to a 1. For normal operation, it should be set to 0.

**Phase Detector Polarity**

The PDP bit in the ADF4360 family sets the phase detector polarity. The positive setting enabled by programming a 1 is used when using the on-chip VCO with a passive loop filter or with an active noninverting filter. It can also be set to 0, which is required if an active inverting loop filter is used.

**DIVOUT Control**

The on-chip multiplexer is controlled by D3, D2, and D1 (see the truth table in Figure 23).

**Counter Reset**

DB4 is the counter reset bit for the ADF4360 family. When this is 1, the R counter and the A, B counters are reset. For normal operation, this bit should be 0.

**Core Power Level**

PC1 and PC2 set the power level in the VCO core. The recommended setting is 5 mA. The 7.5 mA setting is permissible in some applications (see the truth table in Figure 23).

## N COUNTER LATCH

Figure 24 shows the input data format for programming the N counter latch.

### 5-Bit Divider

A5 to A1 program the output divider. The divide range is 2 (00010) to 31 (11111). If unused, this divider should be set to 0. The output or the output divided by 2 is available at the DIVOUT pin.

### Reserved Bits

DB23, DB22, and DB7 are spare bits and are designated as reserved. They should be programmed to 0.

### B Counter Latch

B13 to B1 program the B counter. The divide range is 3 (00 ... 0011) to 8191 (11 ... 111).

### Overall Divide Range

The overall VCO feedback divide range is defined by B.

### CP Gain

DB21 of the N counter latch in the ADF4360 family is the charge pump gain bit. When it is programmed to 1, Current Setting 2 is used. When programmed to 0, Current Setting 1 is used. This bit can also be programmed through DB10 of the control latch. The bit always reflects the latest value written to it, whether this is through the control latch or the N counter latch.

## R COUNTER LATCH

With (C2, C1) = (0, 1), the R counter latch is programmed. Figure 25 shows the input data format for programming the R counter latch.

### R Counter

R1 to R14 set the counter divide ratio. The divide range is 1 (00 ... 001) to 16,383 (111 ... 111).

### Antibacklash Pulse Width

DB16 and DB17 set the antibacklash pulse width.

### Lock Detect Precision

DB18 is the lock detect precision bit. This bit sets the number of reference cycles with <15 ns phase error for entering the locked state. With LDP at 1, five cycles are taken; with LDP at 0, three cycles are taken.

### Test Mode Bit

DB19 is the test mode bit (TMB) and should be set to 0. With TMB = 0, the contents of the test mode latch are ignored and normal operation occurs, as determined by the contents of the control latch, R counter latch, and N counter latch. Note that test modes are for factory testing only and should not be programmed by the user.

### Band Select Clock

These bits (DB20 and DB21) set a divider for the band select logic clock input. The output of the R counter is, by default, the value used to clock the band select logic; if this value is too high (>1 MHz), a divider can be switched on to divide the R counter output to a smaller value (see Figure 25). A value of 8 is recommended.

### Reserved Bits

DB23 to DB22 are spare bits that are designated as reserved. They should be programmed to 0.

## APPLICATIONS

### CHOOSING THE CORRECT INDUCTANCE VALUE

The ADF4360-9 can be used at many different frequencies simply by choosing the external inductors to give the correct output frequency. Figure 27 shows a graph of both minimum and maximum frequency vs. the external inductor value. The correct inductor should cover the maximum and minimum frequencies desired. The inductors used are 0603 CS or 0805 CS type from Coilcraft. To reduce mutual coupling, the inductors should be placed at right angles to one another.

The lowest center frequency of oscillation possible is approximately 65 MHz, which is achieved using 560 nH inductors. This relationship can be expressed by

$$f_o = \frac{1}{2\pi\sqrt{9.3 \text{ pF}(0.9 \text{ nH} + L_{EXT})}}$$

where:

$f_o$  is the center frequency.

$L_{EXT}$  is the external inductance.

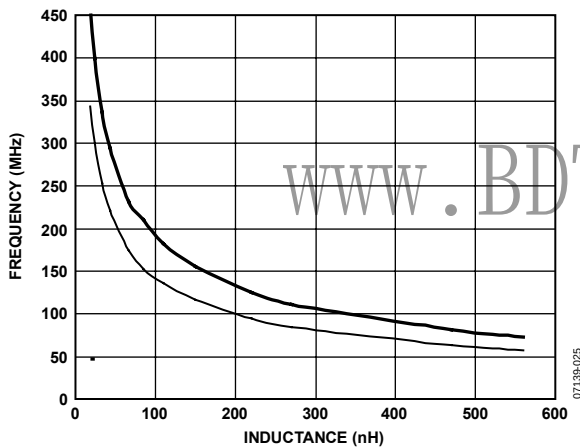


Figure 27. Output Center Frequency vs. External Inductor Value

The approximate value of capacitance at the midpoint of the center band of the VCO is 9.3 pF, and the approximate value of internal inductance due to the bond wires is 0.9 nH. The VCO sensitivity is a measure of the frequency change vs. the tuning voltage. It is a very important parameter for the low-pass filter. Figure 28 shows a graph of the tuning sensitivity (in MHz/V) vs. the inductance (nH). It can be seen that as the inductance increases, the sensitivity decreases. This relationship can be derived from the previous equation; that is, because the inductance increased, the change in capacitance from the varactor has less of an effect on the frequency.

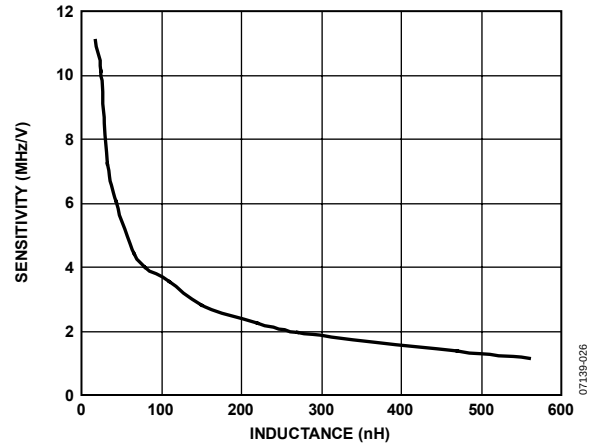


Figure 28. Tuning Sensitivity vs. Inductance

### ENCODE CLOCK FOR ADC

Analog-to-digital converters (ADCs) require a sampling clock for their operation. Generally, this is provided by TCXO or VCXOs, which can be large and expensive. The frequency range is usually quite limited. An alternative solution is the ADF4360-9, which can be used to generate a CMOS clock signal suitable for use in all but the most demanding converter applications.

Figure 29 shows an ADF4360-9 with a VCO frequency of 320 MHz and a DIVOUT frequency of 80 MHz. Because a 50% duty cycle is preferred by most sampling clock circuitry, the A/2 mode is selected. Therefore, A is programmed to 2, giving an overall divide value of 4. The AD9215-80 is a 10-bit, 80 MSPS ADC that requires an encode clock jitter of 6 ps or less. The ADF4360-9 takes a 10 MHz TCXO frequency and divides this to 1 MHz; therefore, R = 10 is programmed and N = 320 is programmed to achieve a VCO frequency of 320 MHz. The resultant 80 MHz CMOS signal has a jitter of <1.5 ps, which is more than adequate for the application.

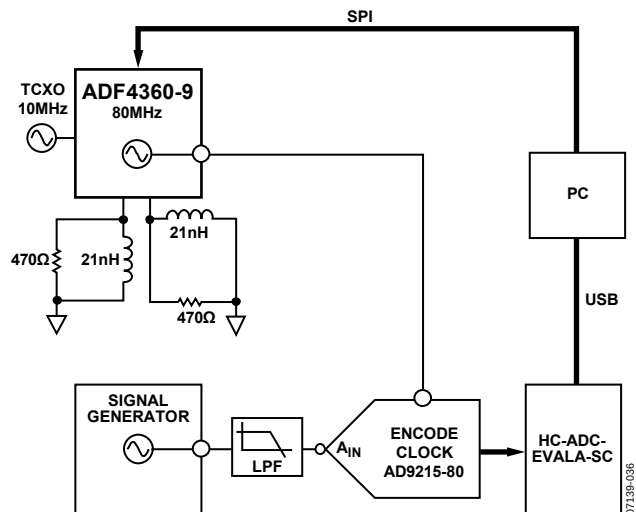


Figure 29. The ADF4360-9 Used as an Encode Clock for an ADC

## GSM TEST CLOCK

Figure 30 shows the ADF4360-9 used to generate three different frequencies at DIVOUT. The frequencies required are 45 MHz, 80 MHz, and 95 MHz. This is achieved by generating 360 MHz, 320 MHz, and 380 MHz and programming the correct A divider ratio. Because a 50% duty cycle is required, the A/2 DIVOUT mode is selected. This means that A values of 4, 2, and 2 are selected, respectively, for each of the output frequencies previously mentioned.

The low-pass filter was designed using ADIsimPLL™ for a channel spacing of 1 MHz and an open-loop bandwidth of 40 kHz. Larger PFD frequencies can be used to reduce in-band noise and, therefore, rms jitter. However, for the purposes of this example, 1 MHz is used. The measured rms jitter from this circuit at each frequency is less than 1.5 ps.

Two 21 nH inductors are required for the specified frequency range. The reference frequency is from a 20 MHz TCXO from Fox; therefore, an R value of 20 is programmed. Taking into account the high PFD frequency and its effect on the band select logic, the band select clock divider is enabled. In this case, a value of 8 is chosen. A very simple shunt resistor and dc-blocking capacitor complete the RF output stage. Because these outputs are not used, they are terminated in 50 Ω resistors. This is recommended for circuit stability. Leaving the RF outputs open is not recommended.

The CMOS level output frequency is available at DIVOUT. If the frequency has to drive a low impedance load, a buffer is recommended.

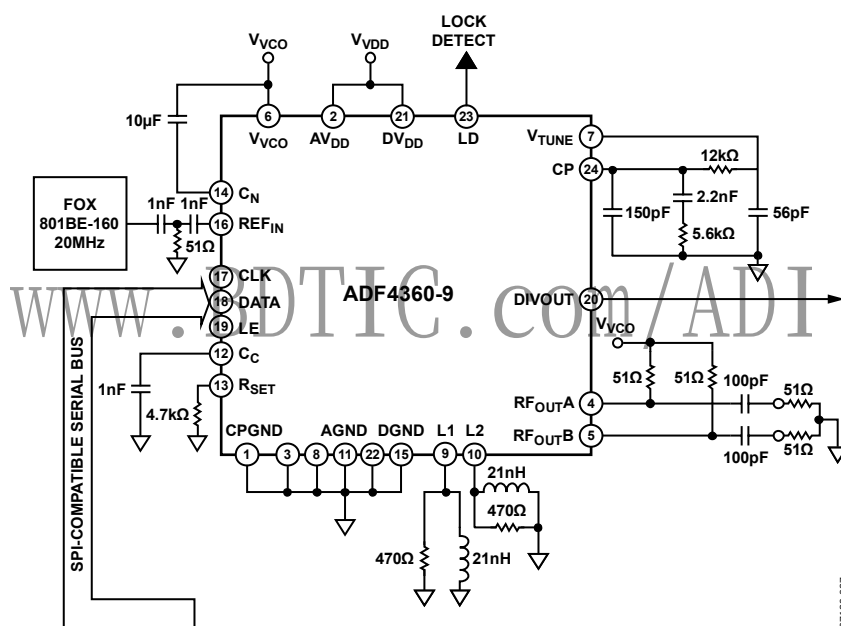


Figure 30. GSM Test Clock

## INTERFACING

The ADF4360 family has a simple SPI-compatible serial interface for writing to the device. CLK, DATA, and LE control the data transfer. When LE goes high, the 24 bits that are clocked into the appropriate register on each rising edge of CLK are transferred to the appropriate latch. See Figure 2 for the timing diagram and Table 5 for the latch truth table.

The maximum allowable serial clock rate is 20 MHz. This means that the maximum update rate possible is 833 kHz, or one update every 1.2  $\mu$ s. This is more than adequate for systems that have typical lock times in hundreds of microseconds.

### ADuC812 Interface

Figure 31 shows the interface between the ADF4360 family and the ADuC812 MicroConverter®. Because the ADuC812 is based on an 8051 core, this interface can be used with any 8051-based microcontrollers. The MicroConverter is set up for SPI master mode with CPHA = 0. To initiate the operation, the I/O port driving LE is brought low. Each latch of the ADF4360 family needs a 24-bit word, which is accomplished by writing three 8-bit bytes from the MicroConverter to the device. After the third byte is written, the LE input should be brought high to complete the transfer.

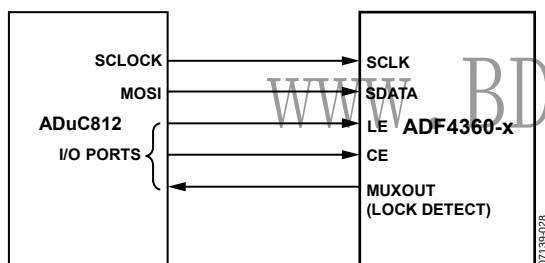


Figure 31. ADuC812 to ADF4360-x Interface

I/O port lines on the ADuC812 are used to detect lock (MUXOUT configured as lock detect and polled by the port input). When operating in the described mode, the maximum SCLOCK rate of the ADuC812 is 4 MHz. This means that the maximum rate at which the output frequency can be changed is 166 kHz.

### ADSP-21xx Interface

Figure 32 shows the interface between the ADF4360 family and the ADSP-21xx digital signal processor. The ADF4360 family needs a 24-bit serial word for each latch write. The easiest way to accomplish this using the ADSP-21xx family is to use the autobuffered transmit mode of operation with alternate framing. This provides a means for transmitting an entire block of serial data before an interrupt is generated.

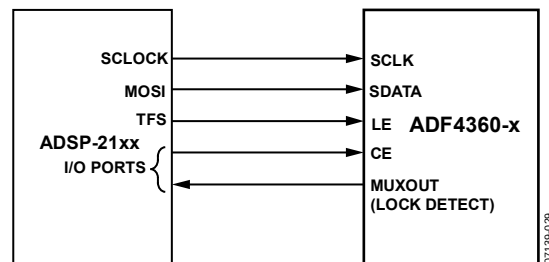


Figure 32. ADSP-21xx to ADF4360-x Interface

Set up the word length for 8 bits and use three memory locations for each 24-bit word. To program each 24-bit latch, store the 8-bit bytes, enable the autobuffered mode, and write to the transmit register of the DSP. This last operation initiates the autobuffer transfer.

### PCB DESIGN GUIDELINES FOR CHIP SCALE PACKAGE

The leads on the chip scale package (CP-24-2) are rectangular. The PCB pad for these should be 0.1 mm longer than the package lead length and 0.05 mm wider than the package lead width. The lead should be centered on the pad to ensure that the solder joint size is maximized.

The bottom of the chip scale package has a central thermal pad. The thermal pad on the PCB should be at least as large as this exposed pad. On the PCB, there should be a clearance of at least 0.25 mm between the thermal pad and the inner edges of the pad pattern to ensure that shorting is avoided.

Thermal vias can be used on the PCB thermal pad to improve thermal performance of the package. If vias are used, they should be incorporated into the thermal pad at 1.2 mm pitch grid. The via diameter should be between 0.3 mm and 0.33 mm, and the via barrel should be plated with 1 ounce of copper to plug the via.

The user should connect the printed circuit thermal pad to AGND. This is internally connected to AGND.

## OUTPUT MATCHING

There are a number of ways to match the VCO output of the ADF4360-9 for optimum operation; the most basic is to use a 51  $\Omega$  resistor to  $V_{VCO}$ . A dc bypass capacitor of 100 pF is connected in series, as shown in Figure 33. Because the resistor is not frequency dependent, this provides a good broadband match. The output power in the circuit in Figure 33 typically gives -9 dBm output power into a 50  $\Omega$  load.

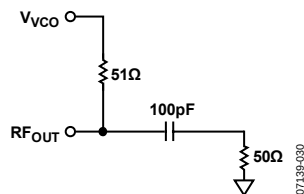


Figure 33. Simple Output Stage

A better solution is to use a shunt inductor (acting as an RF choke) to  $V_{VCO}$ . This gives a better match and, therefore, more output power.

Experiments have shown that the circuit shown in Figure 34 provides an excellent match to 50  $\Omega$  over the operating range of the ADF4360-9. This gives approximately 0 dBm output power across the specific frequency range of the ADF4360-9 using the recommended shunt inductor, followed by a 100 pF dc-blocking capacitor.

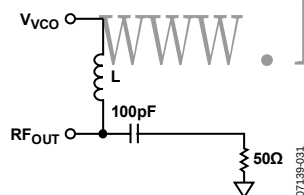


Figure 34. Optimum Output Stage

The recommended value of this inductor changes with the VCO center frequency. Figure 35 shows a graph of the optimum inductor value vs. center frequency.

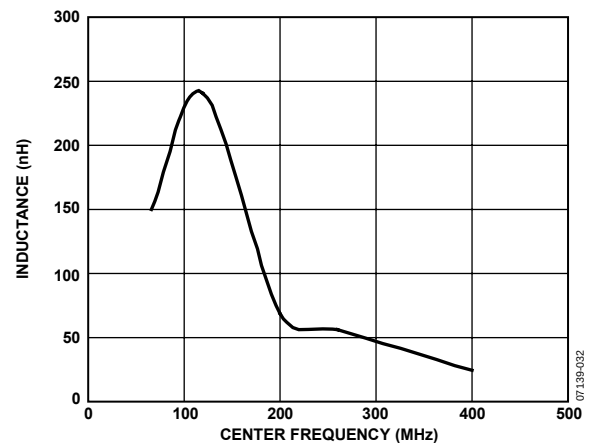
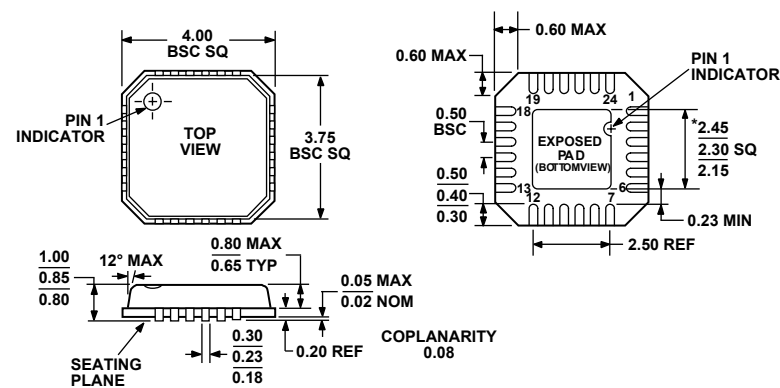


Figure 35. Optimum Shunt Inductor vs. Center Frequency

Both complementary architectures can be examined using the EVAL-ADF4360-9EBZ1 evaluation board. If the user does not need the differential outputs available on the ADF4360-9, the user should either terminate the unused output with the same circuitry as much as possible or combine both outputs using a balun. Alternatively, instead of the LC balun, both outputs can be combined using a 180° rat-race coupler.

If the user is only using DIVOUT and does not use the RF outputs, it is still necessary to terminate both RF output pins with a shunt inductor/resistor to  $V_{VCO}$  and also a dc bypass capacitor and a 50  $\Omega$  load. The circuit in Figure 33 is probably the simplest and most cost-effective solution. It is important that the load on each pin be balanced because an unbalanced load is likely to cause stability problems. Terminations should be identical as much as possible.

OUTLINE DIMENSIONS



\*COMPLIANT TO JEDEC STANDARDS MO-220-VGGD-2  
EXCEPT FOR EXPOSED PAD DIMENSION

Figure 36. 24-Lead Lead Frame Chip Scale Package [LFCSP\_VQ]  
4 mm × 4 mm Body, Very Thin Quad  
(CP-24-2)  
Dimensions shown in millimeters

ORDERING GUIDE

| Model                           | Temperature Range | Package Description | Frequency Range   | Package Option |
|---------------------------------|-------------------|---------------------|-------------------|----------------|
| ADF4360-9BCPZ <sup>1</sup>      | −40°C to +85°C    | 24-Lead LFCSP_VQ    | 65 MHz to 400 MHz | CP-24-2        |
| ADF4360-9BCPZRL <sup>1</sup>    | −40°C to +85°C    | 24-Lead LFCSP_VQ    | 65 MHz to 400 MHz | CP-24-2        |
| ADF4360-9BCPZRL7 <sup>1</sup>   | −40°C to +85°C    | 24-Lead LFCSP_VQ    | 65 MHz to 400 MHz | CP-24-2        |
| EVAL-ADF4360-9EBZ1 <sup>1</sup> |                   | Evaluation Board    |                   |                |

<sup>1</sup> Z = RoHS Compliant Part.